

two together more securely and increase their resistance to delamination and the subsequent penetration of the package by moisture. A mounting and interconnection land is defined on the lower surface of each lead between the locking pad on its outer end and the bonding pad on its inner end."

Page 12, revise ¶ beginning at line 4 to read as follows:

"Those skilled in the packaging art will understand that many variations of the particular embodiments of the novel leadframe and package illustrated and described herein are possible, depending on the particular problem at hand. For example, although a square package 68 is illustrated in the figures, a rectangular or polygonal package is easily constructed in accordance with the teachings herein. Similarly, fewer or greater numbers of leads 16 can be incorporated into the package, on either two, or all sides thereof. Further, the leads 16 can be extended outside of the body 66 of the package 68 and the lands 48 over-molded with plastic to yield a package with peripheral leads, such as those found in a conventional "quad-flat" package."

In accordance with 37 CFR 1.121(b)(1)(iii), Attachment A contains marked up versions of the replacement paragraphs illustrating the newly introduced changes in the specification.

**In the Claims:**

Please cancel claims 1-12, without prejudice.

Please amend claim 13, in accordance with the amendment on Attachment A, to